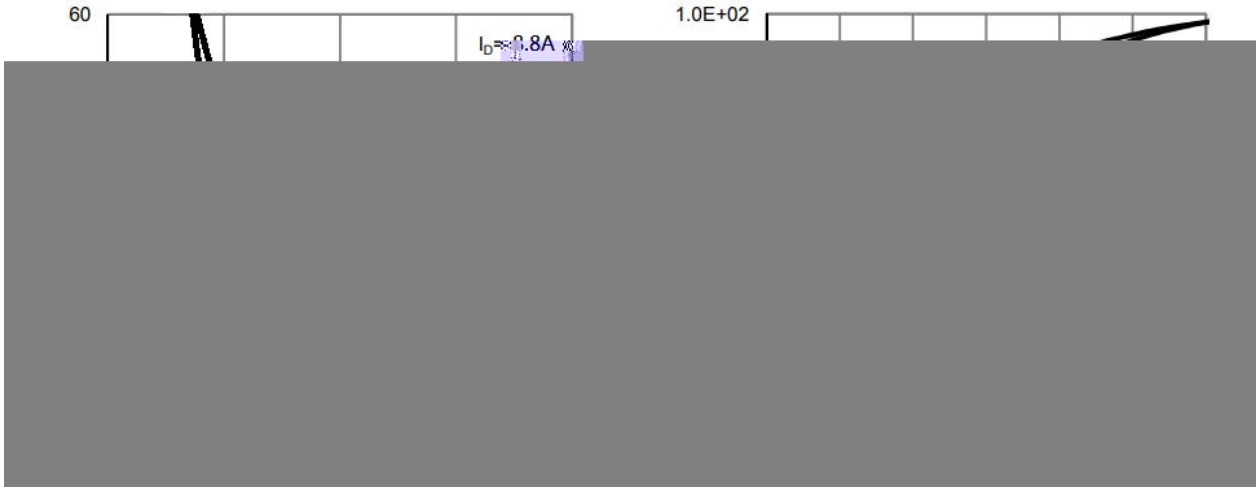
	2020.05.07		AON3419 5 5 1 5 **BR**		

Gate-Source Voltage			
Continuous Drain Current	I_D (T_a=70°C)	-14	A
Pulsed Drain Current	I_{DM}	-56	A
Avalanche energy L=0.5mH	E_{AS}	170	mJ
Power Dissipation for Single Operation	P_D (T_a=25℃)	13	W
Power Dissipation for Single Operation	P_D (T_a=100℃)	5.2	W

''-'' ,>.49304<>' J<3<49.301904' =3/.'







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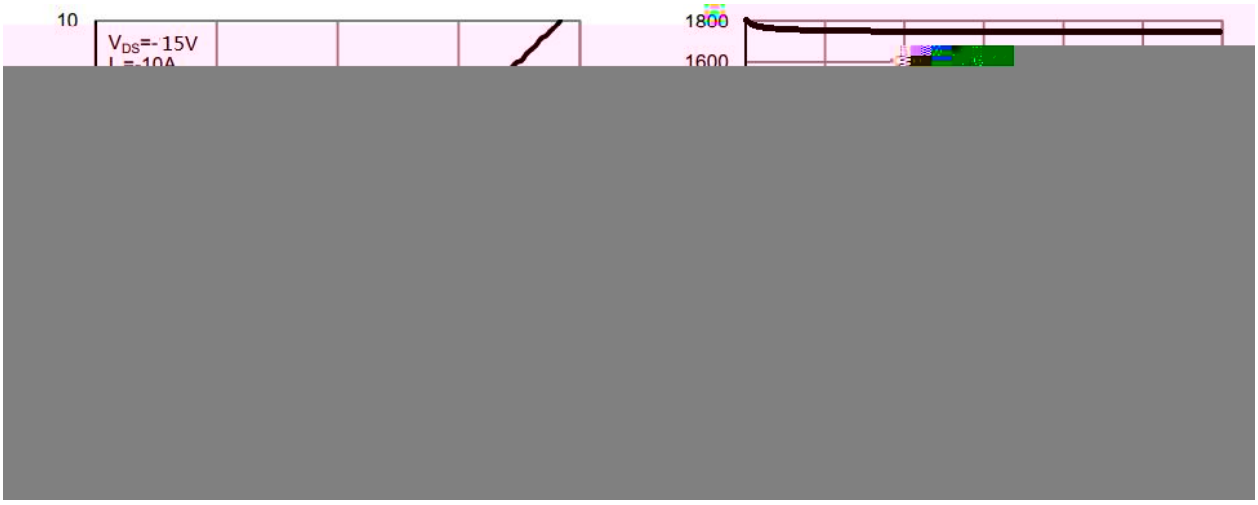

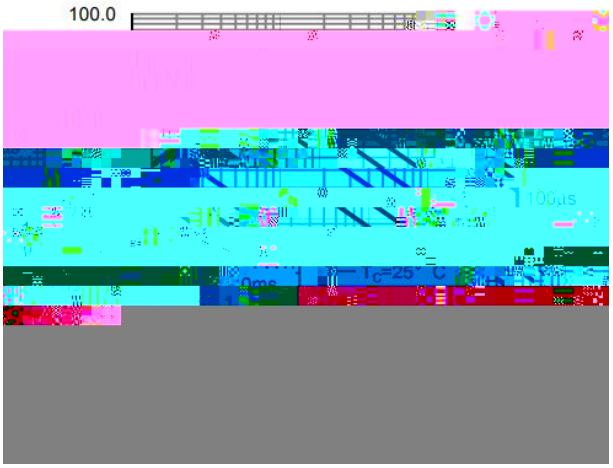

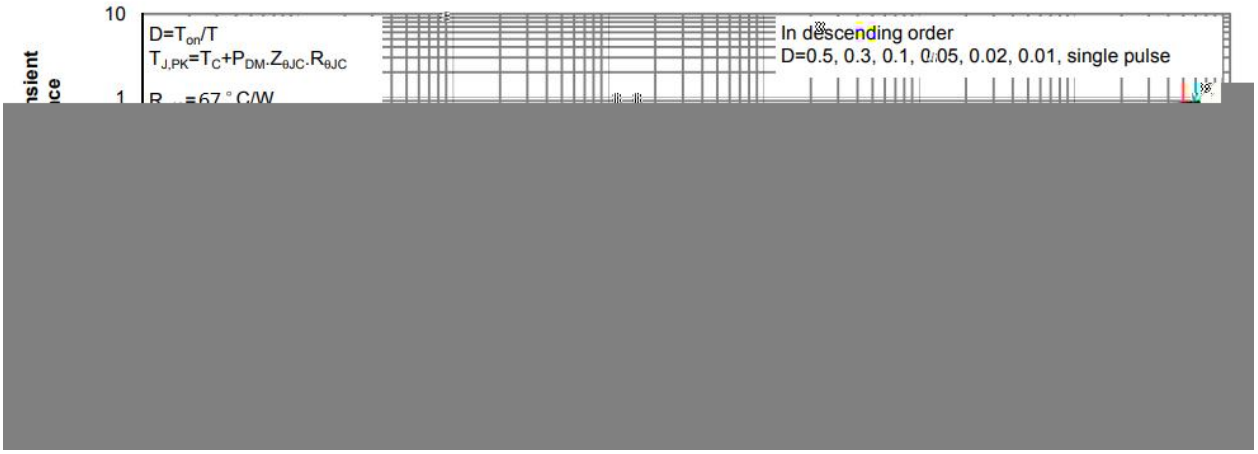

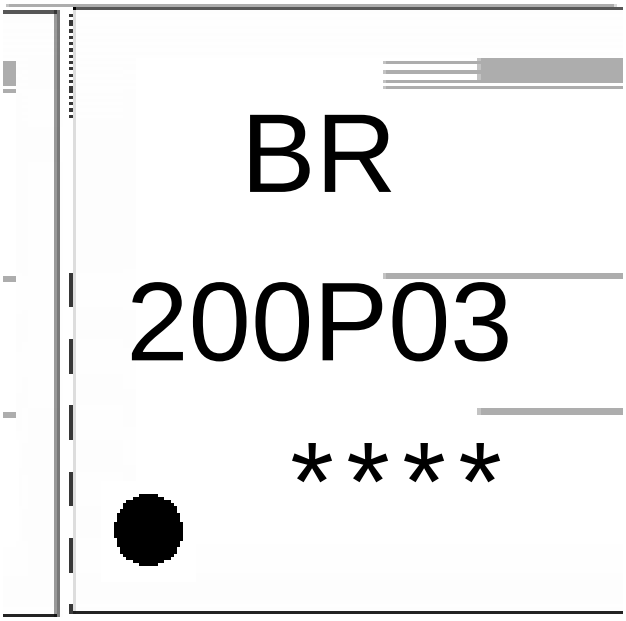

BR

200P03

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Note:

BR:	Company Code.
200P03:	Product Type
****:	Lot No. Code, code change with Lot No

F I' '-' ' Temperature Profile for IR Reflow Soldering(Pb-Free)

				Note:
1	150 180	60 90sec;		1.Preheating:150~180℃, Time:60~90sec.
2	245±5	5±0.5sec;		2.Peak Temp.:245±5℃, Duration:5±0.5sec.
3				